Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings AMR

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage ⁽¹⁾	12	V
V _{id}	Differential input voltage (2)	±1	V
V _{in}	Input voltage (3)	V _{DD} -0.3 to V _{CC} +0.3	V
T _{stg}	Storage temperature range	-65 to +150	
Tj	Maximum junction temperature	150	°C
R _{thja}	Thermal resistance junction to ambient ⁽⁴⁾ SOT23-5 DFN8 SO-8 SO-14 TSSOP8 TSSOP14	250 40 125 105 120 100	°C/W
R _{thjc}	Thermal resistance junction to case ⁽⁴⁾ SOT23-5 DFN8 SO-8 SO-14 TSSOP8 TSSOP14	81 5.2 40 31 37 32	°C/W
	HBM: human body model ⁽⁵⁾	2	kV
ESD	MM: machine model ⁽⁶⁾	200	V
	CDM: charged device model ⁽⁷⁾	1.5	kV
	Lead temperature (soldering, 10sec)	260	°C

- 1. All voltage values, except differential voltage are with respect to network ground terminal.
- 2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
- 3. The magnitude of input and output voltages must never exceed V_{CC} +0.3 V.
- 4. Short-circuits can cause excessive heating and destructive dissipation. Values are typical.
- Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a $1.5 \mathrm{k}\Omega$ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins are floating.
- Charged device model: all pins and package are charged together to the specified voltage and then discharged directly to ground through only one pin. This is done for all pins.
 - No value specified for CDM on SOT23-5 package.

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Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	2.7 to 10	V
V _{icm}	Common mode input voltage range	V _{DD} +1.15 to V _{CC} -1.15	V
T _{oper}	Operating free air temperature range	-40 to +125	°C

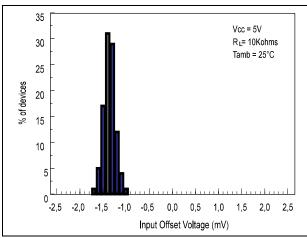
2 Electrical characteristics

Table 3. V_{CC} = +2.5 V, V_{DD} = -2.5 V, T_{amb} = 25°C (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{io}	Input offset voltage	T _{min} ≤T _{amb} ≤T _{max}		1	5 7	mV
DV _{io}	Input offset voltage drift	$V_{icm} = 0 \text{ V}, V_o = 0 \text{ V}$		5		μV/°C
I _{io}	Input offset current	$V_{icm} = 0 \text{ V}, V_o = 0 \text{ V}$		10	150	nA
I _{ib}	Input bias current	$V_{icm} = 0 \text{ V}, V_o = 0 \text{ V}$ $T_{min} \le T_{amb} \le T_{max}$		200 200	750 1000	nA
V _{icm}	Common mode input voltage range		-1.35		1.35	V
CMR	Common mode rejection ratio	$V_{icm} = \pm 1.35 \text{ V}$	60	85		dB
SVR	Supply voltage rejection ratio	$V_{CC} = \pm 2 \text{ V to } \pm 3 \text{ V}$	60	70		dB
A _{vd}	Large signal voltage gain	$R_L = 2 k\Omega$	70	80		dB
V _{OH}	High level output voltage	$R_L = 2 k\Omega$	2	2.4		V
V _{OL}	Low level output voltage	$R_L = 2 k\Omega$		-2.4	-2	V
I _{source}	Output source current			1.5		mA
I _{sink}	Output sink current			100		mA
I _{CC}	Supply current per amplifier	Unity gain - no load		2	2.8	mA
GBP	Gain bandwidth product	$f = 100 \text{ kHz}, R_L = 2 \text{ k}\Omega, C_L = 100 \text{ pF}$	8.5	12		MHz
SR	Slew rate	$A_{V} = 1, V_{in} = \pm 1 V$	2.8	4		V/µs
Øm	Phase margin at unit gain	$R_L = 2 \text{ k}\Omega, \ C_L = 100 \text{ pF}$		60		Degrees
Gm	Gain margin	$R_L = 2 \text{ k}\Omega$, $C_L = 100 \text{ pF}$		10		dB
e _n	Equivalent input noise voltage	f = 100 kHz	_	4	_	nV/√Hz
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = -1, R_L = 10 \text{ k}\Omega$		0.003		%

Figure 1. Input offset voltage distribution

Figure 2. Voltage gain & phase vs. frequency $V_{CC} = 5 \text{ V}$



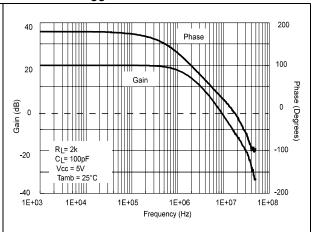
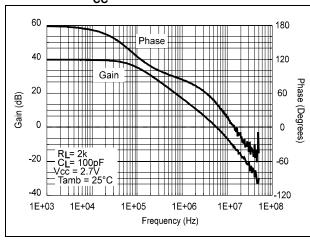


Figure 3. Voltage gain & phase vs. frequency Figure 4. THS vs. V_{out} , V_{CC} = 5 V V_{CC} = 2.7 V



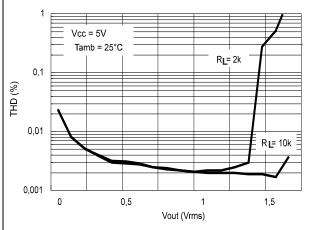
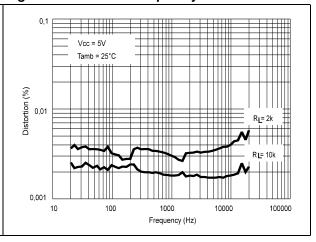


Figure 5. THD vs. Vout, $V_{CC} = 2.7 \text{ V}$

0,01 0,0

Figure 6. THD vs. frequency



577

Figure 7. Noise voltage vs. frequency

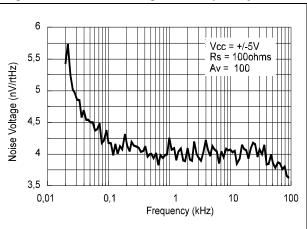


Figure 8. Gain bandwidth product vs. I_{out}

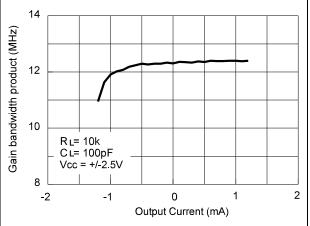
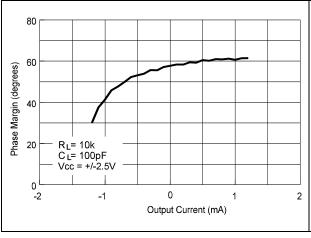


Figure 9. Phase margin vs. Iout

Figure 10. Phase margin vs. V_{CC} $R_L = 10 \text{ k}, C_L = 30 \text{ pF}$



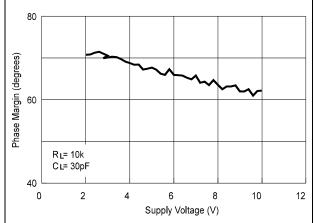
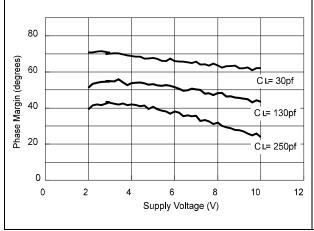
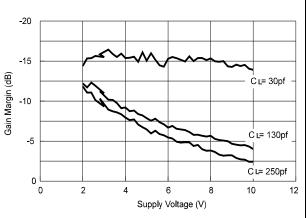


Figure 11. Phase margin vs. V_{CC} $C_L = 30, 130$ and 250 pF

Figure 12. Gain margin vs. V_{CC}





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3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

3.1 SOT23-5 package information

Figure 13. SOT23-5 package mechanical drawing

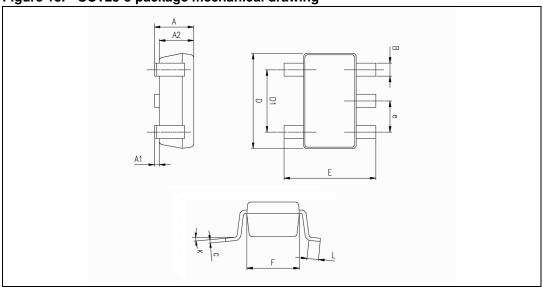


Table 4. SOT23-5 package mechanical data

ыс т.	00120 0 pac	mage meen	armour dutu				
	Dimensions						
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.90	1.20	1.45	0.035	0.047	0.057	
A1			0.15			0.006	
A2	0.90	1.05	1.30	0.035	0.041	0.051	
В	0.35	0.40	0.50	0.013	0.015	0.019	
С	0.09	0.15	0.20	0.003	0.006	0.008	
D	2.80	2.90	3.00	0.110	0.114	0.118	
D1		1.90			0.075		
е		0.95			0.037		
E	2.60	2.80	3.00	0.102	0.110	0.118	
F	1.50	1.60	1.75	0.059	0.063	0.069	
L	0.10	0.35	0.60	0.004	0.013	0.023	
K	0 degrees		10 degrees				

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3.2 SO-8 package information

Figure 14. SO-8 package mechanical drawing

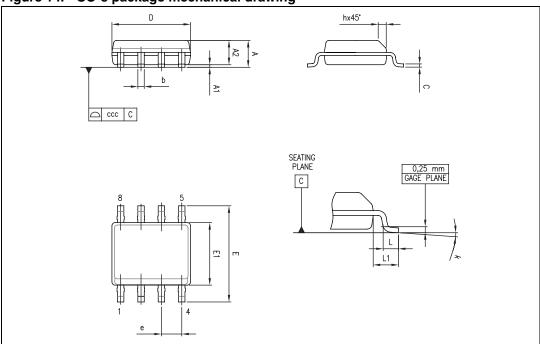


Table 5. SO-8 package mechanical data

			Dimer	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
С	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
L1		1.04			0.040	
k	0°		8°	1°		8°
ccc			0.10			0.004

3.3 TSSOP8 package information

Figure 15. TSSOP8 package mechanical drawing

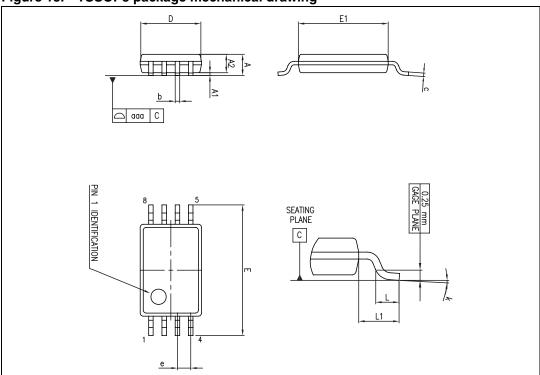


Table 6. TSSOP8 package mechanical data

			Dimer	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			1.20			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
С	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
е		0.65			0.0256	
k	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1.00			0.039	
aaa			0.10			0.004

Ay/

3.4 SO-14 package information

Figure 16. SO-14 package mechanical drawing

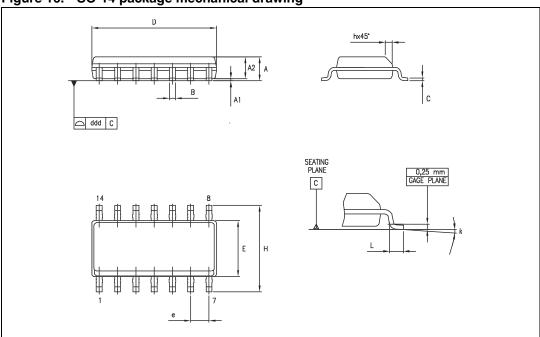


Table 7. SO-14 package mechanical data

	Dimensions					
Def		Millimeters		Inches		
Ref.	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	1.35		1.75	0.05		0.068
A1	0.10		0.25	0.004		0.009
A2	1.10		1.65	0.04		0.06
В	0.33		0.51	0.01		0.02
С	0.19		0.25	0.007		0.009
D	8.55		8.75	0.33		0.34
E	3.80		4.0	0.15		0.15
е		1.27			0.05	
Н	5.80		6.20	0.22		0.24
h	0.25		0.50	0.009		0.02
L	0.40		1.27	0.015		0.05
k	8° (max.)					
ddd			0.10			0.004

3.5 TSSOP14 package information

Figure 17. TSSOP14 package mechanical drawing

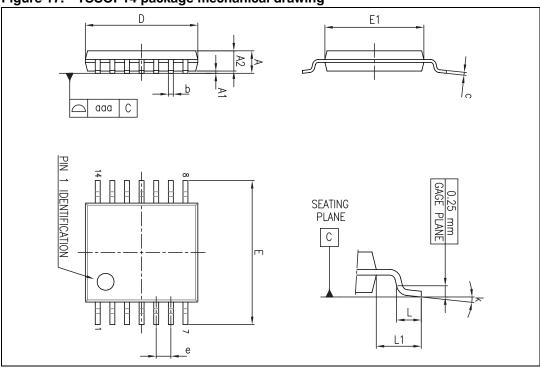


Table 8. TSSOP14 package mechanical data

	Dimensions							
Ref.		Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α			1.20			0.047		
A1	0.05		0.15	0.002	0.004	0.006		
A2	0.80	1.00	1.05	0.031	0.039	0.041		
b	0.19		0.30	0.007		0.012		
С	0.09		0.20	0.004		0.0089		
D	4.90	5.00	5.10	0.193	0.197	0.201		
E	6.20	6.40	6.60	0.244	0.252	0.260		
E1	4.30	4.40	4.50	0.169	0.173	0.176		
е		0.65			0.0256			
L	0.45	0.60	0.75	0.018	0.024	0.030		
L1		1.00			0.039			
k	0°		8°	0°		8°		
aaa			0.10			0.004		

3.6 DFN8 exposed pad package information

Figure 18. DFN8 3 x 3 exposed pad package mechanical drawing (pitch 0.5 mm)

SEATING PLANE

1 2 3 4

1 4 5 5

8 7 6 5

Table 9. DFN8 3 x 3 mm exposed pad package mechanical data (pitch 0.5 mm)

			Dimer	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.80	0.90	1.00	0.031	0.035	0.039
A1		0.02	0.05		0.0008	0.0019
A2	0.55	0.65	0.80	0.021	0.025	0.031
A3		0.20			0.008	
b	0.18	0.25	0.30	0.007	0.010	0.012
D	2.85	3.00	3.15	0.112	0.118	0.124
D2	2.20		2.70	0.087		0.106
E	2.85	3.00	3.15	0.112	0.118	0.124
E2	1.40		1.75	0.055		0.069
е		0.50			0.020	
L	0.30	0.40	0.50	0.012	0.016	0.020
ddd			0.08			0.003

4 Ordering information

Table 10. Order codes

Order code	Temperature range	Package	Packing	Marking
TS971ID TS971IDT		SO-8	Tube or Tape & reel	9711
TS971ILT		SOT23-5L		K120
TS971IYD ⁽¹⁾ TS971IYDT ⁽¹⁾		SO-8 (Automotive grade level)	Tape & reel	971IY
TS971IYLT ⁽²⁾		SOT23-5L (Automotive grade level)		K121
TS972ID TS972IDT	-40°C, +125°C	SO-8	Tube or Tape & reel	
TS972IPT		TSSOP8 (Thin shrink outline package)	Tape & Reel	9721
TS972IQT		DFN8 (Dual micro lead frame package)	Tape & Fleet	
TS972IYD ⁽¹⁾ TS972IYDT ⁽¹⁾		SO-8 (Automotive grade level)	Tube or Tape & reel	972IY
TS972IYPT ⁽²⁾		TSSOP8 (Automotive grade level)	Tape & reel	972IY
TS974ID TS974IDT		SO-14	Tube or Tape & reel	9741
TS974IPT		TSSOP14 (Thin shrink outline package)		3741
TS974IYD ⁽¹⁾ TS974IYDT ⁽¹⁾		SO-14 (Automotive grade level)	Tape & reel	974IY
TS974IYPT ⁽²⁾		TSSOP14 (Automotive grade level)		974IY

Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent.

^{2.} Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent are on-going.

TS971, TS972, TS974 Revision history

5 Revision history

Table 11. Document revision history

Date	Revision	Changes
15-Nov- 2002	1	First release.
9-May- 2005	2	Modifications on AMR table (explanation of V _{id} and V _i limits)
31-Aug-2005	3	PPAP references inserted in the datasheet, see Table 1 on page 2.
9-Dec-2005	4	Thermal resistance junction to case data added in <i>Table 1. on page 2</i> Missing PPAP references inserted in the datasheet, see <i>Table 10:</i> Order codes.
3-Oct-2007	5	Added R _{thja} and R _{thjc} values for DIP8 and DIP14 packages in <i>Table 1</i> . ESD footnotes updated in <i>Table 1: Absolute maximum ratings AMR</i> . Description section updated on cover page. Markings for automotive grade parts corrected in <i>Table 10: Order codes</i> .
20-Dec-2007	6	Reformatted package information in <i>Section 3: Package information</i> . Footnotes for automotive grade parts corrected in <i>Table 10: Order codes</i> .
06-May-2010	7	Updated package information (drawings and data) in <i>Chapter 3</i> . Removed DIP package order codes from <i>Chapter 4: Ordering information</i> .

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